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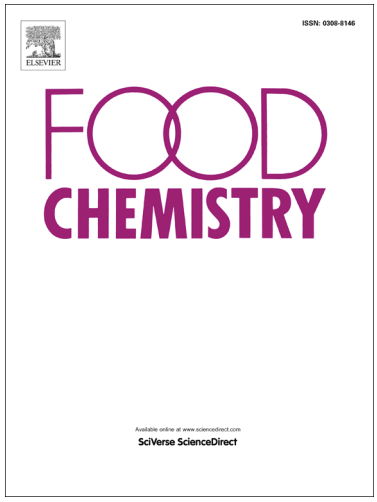

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Stephen Young, Nitin Nitin

PII: S0308-8146(18)31535-8
DOI: https://doi.org/10.1016/j.foodchem.2018.08.121
Reference: FOCH 23463

To appear in: *Food Chemistry*

Received Date: 12 February 2018
Revised Date: 17 August 2018
Accepted Date: 27 August 2018

Please cite this article as: Young, S., Nitin, N., Thermal and Oxidative Stability of Curcumin Encapsulated in Yeast Microcarriers, *Food Chemistry* (2018), doi: https://doi.org/10.1016/j.foodchem.2018.08.121

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Thermal and Oxidative Stability of Curcumin Encapsulated in Yeast Microcarriers

Stephen YOUNG [a], Nitin NITIN [a,b,*]

[a] Department of Food Science and Technology, University of California-Davis, Davis, CA 95616, United States

[b] Department of Agricultural and Biological Engineering, University of California-Davis, Davis, CA 95616, United States

[*] Corresponding author

First Author Contact E-mail: syoung@ucdavis.edu

Corresponding Author E-mail: nnitin@ucdavis.edu

Corresponding Author Telephone Number: +1 (530) 752-6208

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